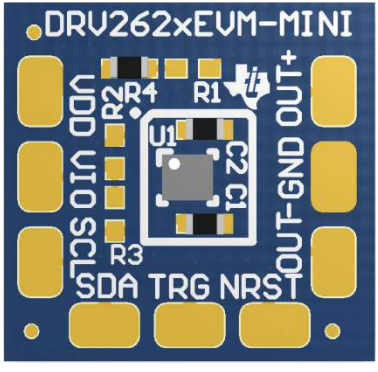
DRV2625 Break-out Board

DRV2625EVM-MINI

Quick-Start Guide

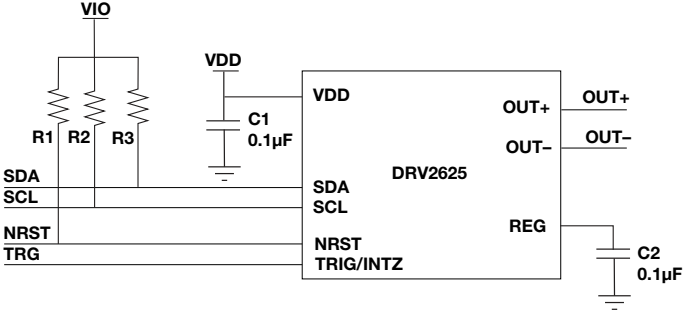
Start Here



ti.com/tool/drv2625evm-mini

Getting Started

1. To power the DRV2625, connect wires to VDD and GND.
2. Connect pads SCL and SDA to an external I²C controller.
3. Connect the actuator to OUT+ and OUT-, polarity does not matter.
4. If there are no I²C pull-up resistors, populate R2 and R3 with a resistor above 3.3k
5. Connect NRST to a GPIO or directly to VDD to enable the DRV2625.
6. Begin communicating with the DRV2625 using Haptic Control Console or any other I²C interface.



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